

## Electronic Patent Application Fee Transmittal

Application Number:	10687112								
Filing Date:	15-Oct-2003								
Title of Invention:	Processes and tools for forming lead-free alloy solder precursors								
First Named Inventor/Applicant Name:	Bioh Kim								
Filer:	Emily Catharine Peyser/Carole Julyan								
Attorney Docket Number:	SEMT116964								
Filed as Large Entity									
<b>Utility Filing Fees</b> <table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 30%;">Description</th> <th style="width: 15%;">Fee Code</th> <th style="width: 15%;">Quantity</th> <th style="width: 15%;">Amount</th> <th style="width: 15%;">Sub-Total in USD(\$)</th> </tr> </thead> </table>					Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)					
Basic Filing:									
Pages:									
Claims:									
Miscellaneous-Filing:									
Petition:									
Patent-Appeals-and-Interference:									
Post-Allowance-and-Post-Issuance:									
Extension-of-Time:									
Extension - 3 months with \$0 paid	1253	1	1020	1020					

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Miscellaneous:</b>				
<b>Total in USD (\$)</b>				<b>1020</b>